

Preliminary Datasheet

N-Channel 20-V (D-S) MOSFET

FEATURES

- Advance Trench Process Technology
- High Density Cell Design for Ultra Low On-resistance

Application

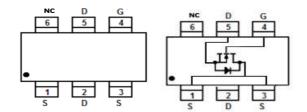
- ●Portable Devices
- ■Consumer Electronics

Mechanical

●Case: SOT-23-6 Package

PRODUCTY SUMMARY V_{DS} $R_{DS(on)} m(Ω)$ $I_{D}(A)$ 10 $@V_{GS}=4.5V$ 5.5 11 $@V_{GS}=3.8V$ 5.5 12 $@V_{GS}=2.5V$ 5.0

SOT-23-6



Packing Information

Package	Packing			
SOT-23-6	3Kpcs / 7" Reel			

Maximum Ratings (T _A =25℃ unless otherwise specified)					
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	20	V		
Gate-Source Voltage	V_{GS}	±12	V		
Continuous Drain Current 1)	I _D	7.2	А		
Maximum Power Dissipation	P_{D}	0.5	W		
Pulsed Drain Current 2)	I _{DM}	28.8	А		
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C		

Typical Thermal Resistance						
Parameter	Symbol	Limit	Unit			
Junction-to-Ambient Thermal Resistance	$R_{\theta JA}$	100	°C/W			

Note:

 $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper



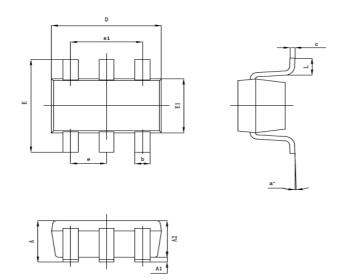
Electrical Characteristics (T _A = 25°C UNLESS OTHERWISE NOTED)						
Characteristics	Symbol	Test Condition	Limits			l lmit
Characteristics			Min	Тур	Max	Unit
Static						
Drain-Source Breakdown Voltage	B _{VDSS}	$V_{GS} = 0V, I_{D} = 250uA$	20	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250uA$	0.40	-	1.00	V
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =4.5V, I _D =5.5A		7	10	mΩ
		V _{GS} =3.8V, I _D =5.5A		8.5	11	mΩ
		V _{GS} =2.5V, I _D =5.0A		9.4	12	mΩ
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =16V, V _{GS} =0V	-	-	1.0	uA
Gate-Source Leakage Current	I _{GSS}	$V_{GS}=\pm 12V, V_{DS}=0V$			±100	nA
Drain-Source Diode						
Maximum Continuous Body Diode Forward Current	I _s	-	-	-	1.2	А
Diode Forward Voltage	V_{SD}	I _S =1.0A, V _{GS} =0V	-	-	1.5	V

NOTES:

- 1. Pulse width<300us, Duty cycle<2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Repetitive rating, pulse width limited by junction temperature TJ(MAX)=150 $^{\circ}$ C. Ratings are based on low frequency and duty cycles to keep initial TJ =25 $^{\circ}$ C.
- 4. The maximum current rating is package limited.
- 5. RQJA is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch2 with 2oz.square pad of copper.
- 6. Guaranteed by design, not subject to production testing.

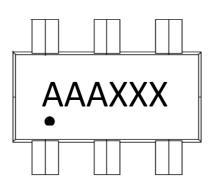


Package Outline Dimensions (inches and millimeters)



SOT-23-6					
	Dimensions				
SYMBOL	OL Millimeters		Inc	hes	
	Min	Max	Min	Max	
Α	-	1.350	-	0.053	
A1	0.040	-	0.002	-	
A2	0.900	1.300	0.035	0.051	
b	0.350	0.480	0.014	0.019	
С	0.080	0.210	0.003	0.008	
D	2.720	3.120	0.107	0.123	
E	2.600	3.000	0.102	0.118	
е	1.80BSC		0.070BSC		
e1	1.90BSC		0.074BSC		
L	0.300	0.600	0.012	0.024	
a °	0 .	8.	0.	8.	

Marking Information



AAA = Product number XXX = Tracking number

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